Product data sheet

1. General description

Dual common cathode power Schottky diode designed for high frequency switched mode power supplies in a TO220F "full pack" plastic package.





2. Features and benefits

- Trench structure
- High junction temperature up to 150 °C
- · Low forward voltage drop, negligible switching losses
- High efficiency

3. Applications

- · DC to DC converters
- Freewheeling diode
- OR-ing diode

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		100		V		
$I_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; per diode; Fig. 1; Fig. 2; Fig. 3	10		А		
I _{O(AV)}	average output current	δ = 0.5 ; square-wave pulse; both diodes conducting	20		А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V_{F}	forward voltage	I _F = 5 A; T _j = 25 °C; per diode; <u>Fig. 6</u>		-	0.54	0.62	V
		I _F = 5 A; T _j = 125 °C; per diode; <u>Fig. 6</u>		-	0.51	0.58	V
		I _F = 10 A; T _j = 25 °C; per diode; <u>Fig. 6</u>		-	0.68	0.75	V
		$I_F = 10 \text{ A}; T_j = 125 ^{\circ}\text{C}; \text{ per diode}; Fig. 6$		-	0.63	0.7	V
I _R	reverse current	$V_R = 100 \text{ V}; T_j = 25 \text{ °C}; \text{ per diode}; Fig. 7; Fig. 8$		-	-	50	μΑ
		$V_R = 100 \text{ V}; T_j = 125 ^{\circ}\text{C}; \text{ per diode}; $ Fig. 7; Fig. 8		-	-	15	mA

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	mb	
2	K	cathode		A1 A2
3	A2	anode 2		K sym125
mb	n.c.	mounting base; isolated		Symres

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WN3S20H100CX	TO220F	WN3S20H100CXQ	Tube	50	SOT186A	14-Nov-2013

7. Marking

Table 4. Marking codes

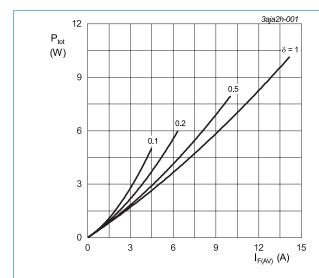
Type number	Marking codes
WN3S20H100CX	WN3S 20H100CX

8. Limiting values

Table 5. Limiting values

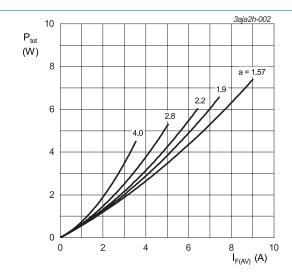
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		100	V
V_{RWM}	crest working reverse voltage		100	V
V_R	reverse voltage	DC	100	V
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; per diode; Fig. 1; Fig. 2; Fig. 3	10	А
$I_{O(AV)}$	average output current	δ = 0.5 ; square-wave pulse; both diodes conducting	20	Α
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode; Fig. 4	180	А
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	198	Α
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$ $V_o = 0.531 \text{ V; } R_s = 0.0131 \text{ }Ω$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode



a = form factor = $I_{F(RMS)}$ / $I_{F(AV)}$ V_o = 0.531 V; R_s = 0.0131 Ω

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values; per diode

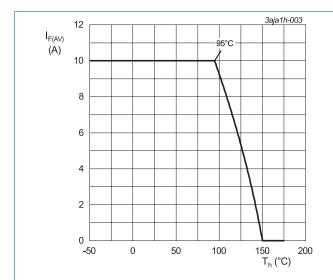


Fig. 3. Average forward current as a function of heatsink temperature; maximum values; per diode

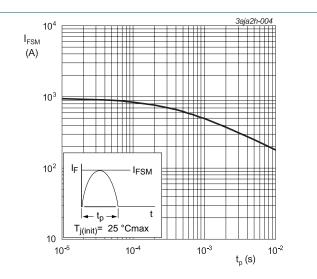


Fig. 4. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values; per diode

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to	with heatsink compound; per diode; Fig. 5	-	-	7	K/W
	heatsink	with heatsink compound; both diodes conducting	-	-	4.8	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	65	-	K/W

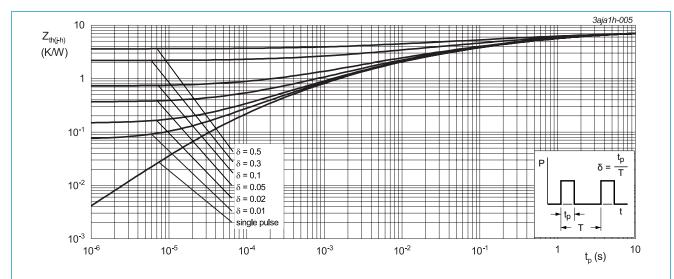


Fig. 5. Transient thermal impedance from junction to heatsink as a function of pulse duration; maximum values; per diode

10. Isolation characteristics

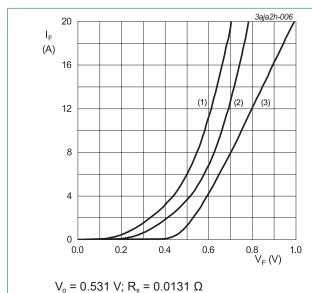
Table 7. Isolation characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; T _h = 25 °C; RH \leq 65 %	-	-	2500	V

11. Characteristics

Table 8. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static characteristics							
V _F forward voltage		$I_F = 5 \text{ A}$; $T_j = 25 \text{ °C}$; per diode; Fig. 6		-	0.54	0.62	V
		I _F = 5 A; T _j = 125 °C; per diode; <u>Fig. 6</u>		-	0.51	0.58	V
		I _F = 10 A; T _j = 25 °C; per diode; <u>Fig. 6</u>		-	0.68	0.75	V
		I _F = 10 A; T _j = 125 °C; per diode; <u>Fig. 6</u>		-	0.63	0.7	V
I _R	reverse current	$V_R = 100 \text{ V}; T_j = 25 \text{ °C}; \text{ per diode}; $ Fig. 7; Fig. 8		-	-	50	μΑ
		$V_R = 100 \text{ V}; T_j = 125 \text{ °C}; \text{ per diode}; $ Fig. 7; Fig. 8		-	-	15	mA



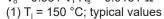
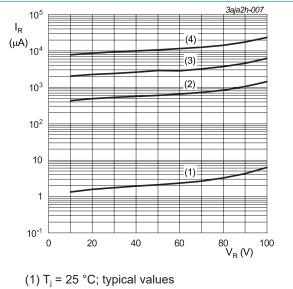


Fig. 6. Forward current as a function of forward voltage; per diode



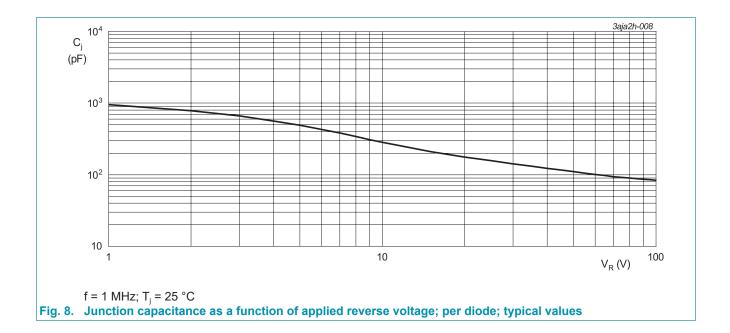
⁽²⁾ T_i = 100 °C; typical values

Fig. 7. Reverse leakage current as a function of reverse voltage; per diode; typical values

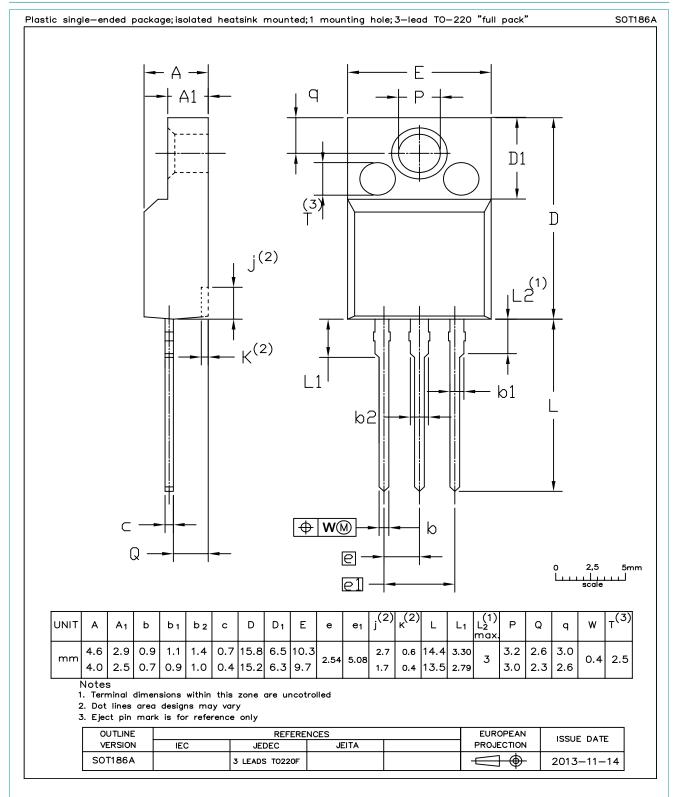
⁽²⁾ T_i = 150 °C; maximum values

⁽³⁾ $T_i = 25$ °C; maximum values

⁽³⁾ $T_j = 125$ °C; typical values (4) $T_j = 150$ °C; typical values



12. Package outline



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 23 November 2021

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